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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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FAIRC	47L	® MOOFET			March 2015			
4UV N- 40V, 50A,	Channel PowerTrench	" MOSFEI						
Features		ripti	ion					
 Max r_{DS(on)} = Fast Switching 	-	This N-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench [®] technology to deliver low $r_{DS(on)}$ and optimized BV _{DSS} capability to offer superior performance benefit in the application.						
RoHS Comp		Applications						
		InverterPower Supplies						
MOSFET	G S D-PAK (TO-252) Maximum Ratings T _C = 25°C unless o	G 🔿 therwise noted		D				
Symbol	Parameter			Ratings	Units			
V _{DS}	Drain to Source Voltage			40	V			
V _{GS}	Gate to Source Voltage			±20	V			
1_	Drain Current -Continuous (Package limited)	T _C = 25°C		50				
	-Continuous (Silicon limited)	T _C = 25°C		57	Α			
ID	-Continuous	T _A = 25°C (No	te 1a)	15.2	~ ~			
	-Pulsed			100				
I _S	Max Pulse Diode Current			100	A			
E _{AS}	Drain-Source Avalanche Energy	(N	ote 3)	153	mJ			
	Dewer Dissinction T = 25%C			4.4				

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Package

D-PAK(TO-252)

T_C= 25°C

T_A= 25°C

T_A= 25°C

Operating and Storage Junction Temperature Range

Thermal Resistance, Junction to Case

Thermal Resistance, Junction to Ambient

Thermal Resistance, Junction to Ambient

Device

FDD8447L

Power Dissipation

Package Marking and Ordering Information

 P_D

T_J, T_{STG}

 $\mathsf{R}_{\theta\mathsf{JC}}$

 $\mathsf{R}_{\theta\mathsf{J}\mathsf{A}}$

 $R_{\theta JA}$

FDD8447L Rev. 1.2

Thermal Characteristics

Device Marking

FDD8447L

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Quantity

2500 units

W

°C

°C/W

44

3.1

1.3

-55 to +150

2.8

40

96

Tape Width

16mm

(Note 1a)

(Note 1b)

(Note 1a)

(Note 1b)

Reel Size

13"

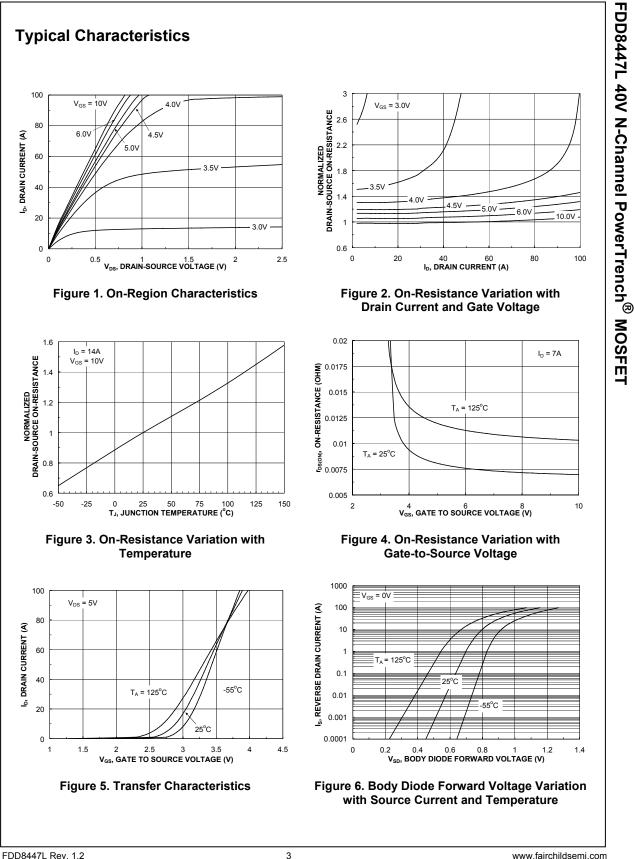
FDD8447L 40V N-Channel PowerTrench[®] MOSFET

FDD8447L 4
40V
N-Channel
PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics				r	
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V
ΔBV_{DSS} ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		35		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32V, V _{GS} = 0V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{GS} = 0V$			±100	nA
	icteristics (Note 2)			-		
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.9	3.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		1.0	1.0	0.0	
ΔT_J	Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-5		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10V, I _D = 14A		7.0	8.5	mΩ
		V _{GS} = 4.5V, I _D = 11A		8.5	11.0	
		V _{GS} = 10V, I _D = 14A, T _J =125°C		10.4	14.0	
9 _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 14A		58		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1970		pF
C _{oss}	Output Capacitance	$V_{\rm DS}$ = 20V, $V_{\rm GS}$ = 0V,		250		pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		150		pF
R _g	Gate Resistance	f = 1MHz		1.27		Ω
	g Characteristics					1
t _{d(on)}	Turn-On Delay Time			12	21	ns
t _r	Rise Time	V _{DD} = 20V, I _D = 1A		12	21	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, R _{GEN} = 6Ω 		38	61	ns
t _f	Fall Time			9	18	ns
Q _{g(TOT)}	Total Gate Charge, V _{GS} = 10V			37	52	nC
Q _{g(TOT)}	Total Gate Charge, V _{GS} = 5V	$V_{DD} = 20V, I_D = 14A$ $-V_{GS} = 10V$		20	28	nC
Q _{gs}	Gate to Source Gate Charge			6	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			7		nC
*	urce Diode Characteristics			,		
	Maximum Continuous Drain-Source Diode	Forward Current (Note 1a)			2.6	A
I _S V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 14A$ (Note 2)		0.8	1.2	V
	Reverse Recovery Time	$V_{GS} = 00, I_S = 14A$ (Note 2) $I_F = 14A, di/dt = 100A/\mu s$		22	1.2	
$\frac{t_{rr}}{0}$	Reverse Recovery Charge			11		ns nC
Q _{rr}	Neverse Neuvery Charge			11		IIC

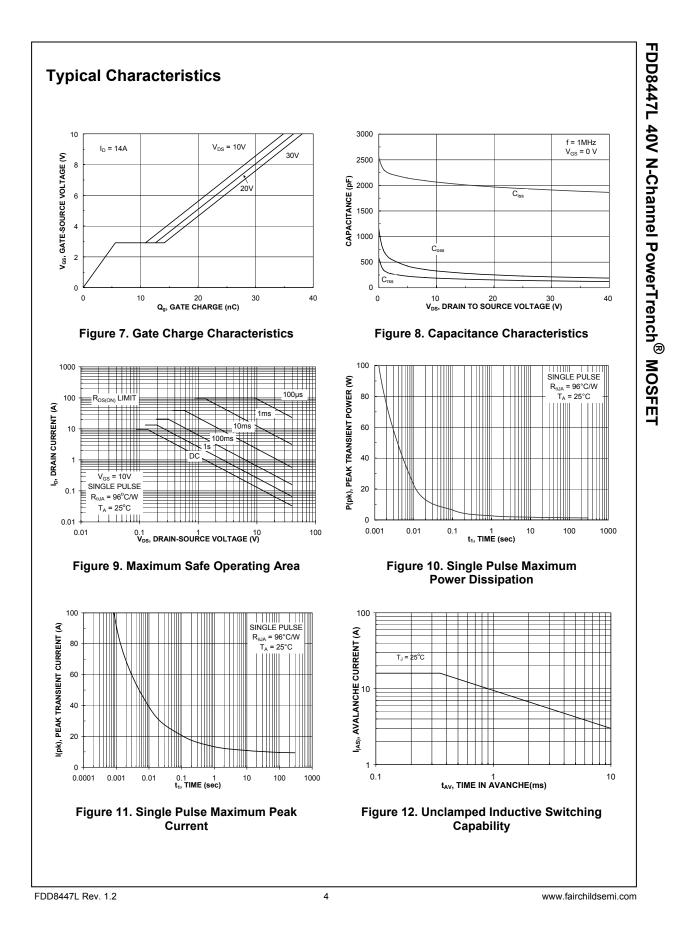
a. 40°C/W when mounted on a 1 in2 pad of 2 oz copper

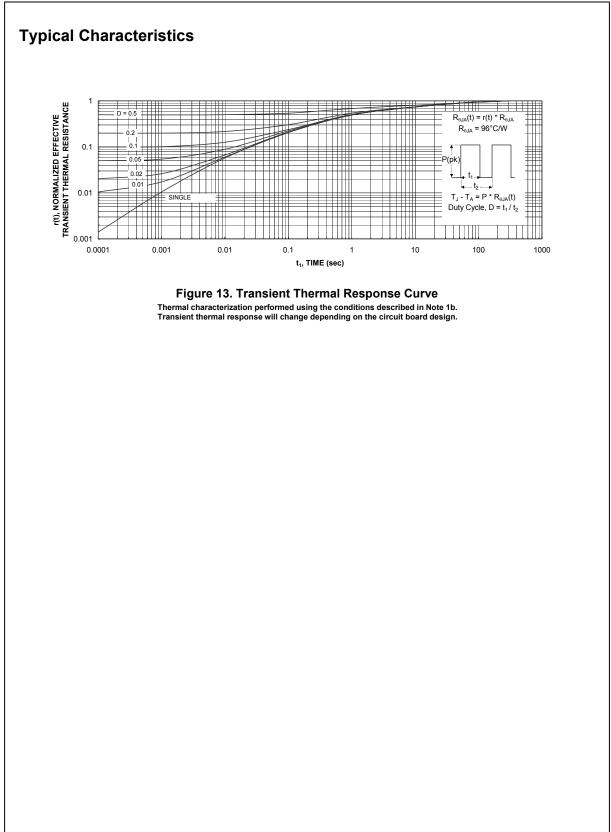
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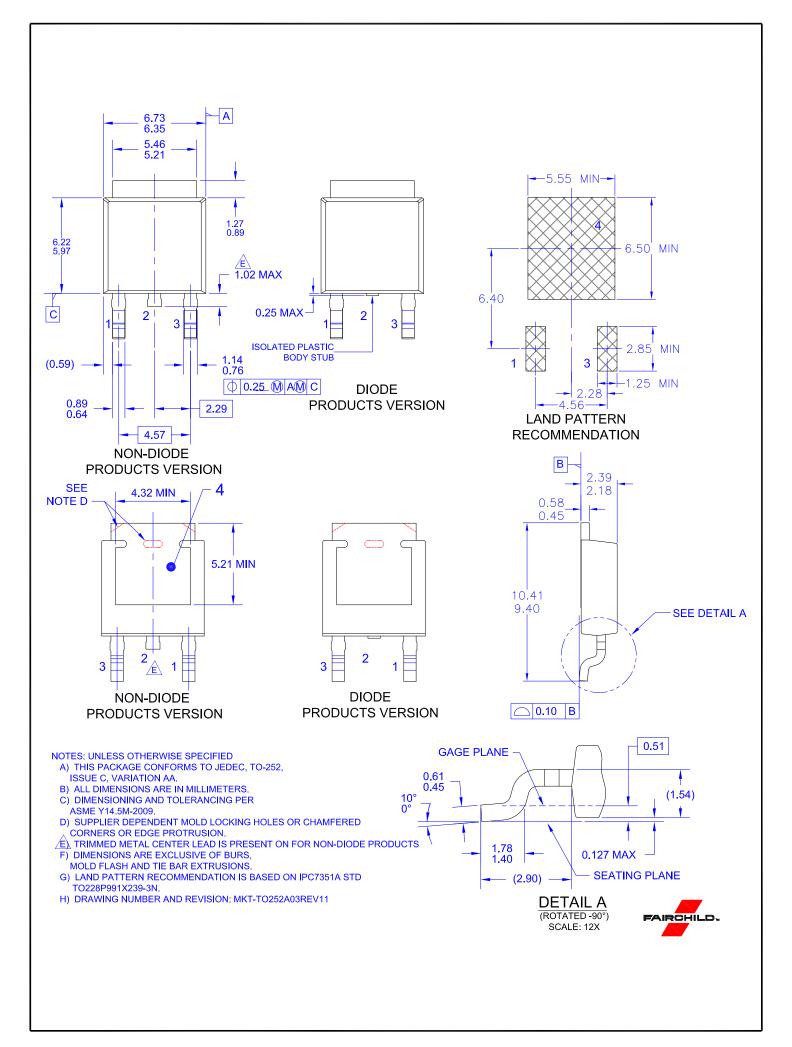




FDD8447L 40V N-Channel PowerTrench[®] MOSFET

FDD8447L Rev. 1.2

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